AN93CO2NSB

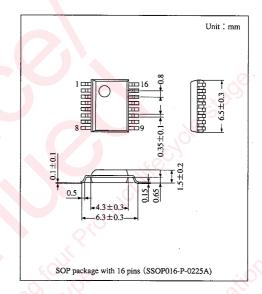
Pager IF IC

Overview

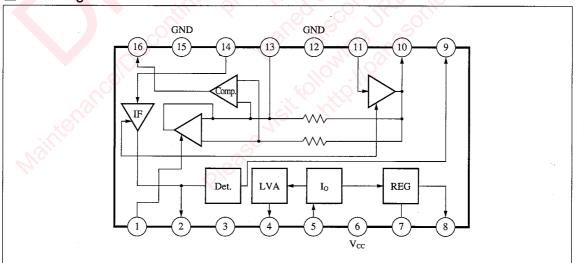
The AN93C02NSB is a pager IF IC. It incorporates an RF bipolar process to minimize current consumption.

Features

- Operates on low voltage (V_{CC}=1.0V to 1.8V)
- Low current consumption (I_{cc}=typically 450 μA)
- Battery saving function: zero current consumption
- Low voltage alarm (LVA)



Block Diagram



■ Pin Description

Pin No.	Description	Pin No.	Description	
1	QCC	9	AF output	
2	IF amp. output	10	LP output	
3	DET	11	LP input	
4	LVA low voltage alarm output DET	12	GND2	
5	BSV input	13	REF	
6	V _{CC}	14	IF input	
7	REG control	15	GND1	
8	REG output	16	NRZ output	

■ Absolute Maximum Ratings $(Ta=25^{\circ}C)$

Parameter	Symbol	Rating	Unit
Supply voltage	V _{cc}	2.0	V
Supply current	I _{cc}	2.0	mA
Power dissipation	P _D	5.0	mW
Operating ambient temperature	Topr	-20 to 70	$^{\circ}$
Storage temperature	T _{stg}	-55 to 125	C

■ Operating Supply Voltage Range

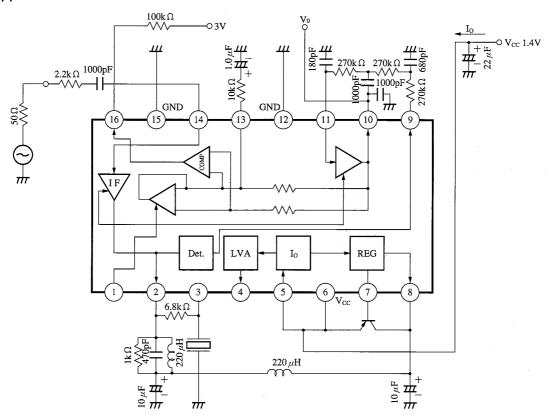
Parameter	Symbol	Range	
Operating supply voltage range	V _{cc}	1.0V to 1.8V	

\blacksquare Electrical Characteristics $(Ta=25\pm2\%, V_{CC}=1.4V)$

Parameter	Symbol	Condition	min	typ	max	Uni
Current consumption (operating)	Io		300	450	500	μ A
Current consumption (quiescent)	Is	SW1:b		0	10	μ A
Low voltage alarm output voltage (L)	V_{L}	$V_{CC}=1.03V$			0.2	V
Low voltage alarm output voltag (H)	V_{H}	$V_{CC} = 1.11V$	2.8		·	V
Low voltage alarm voltage	V_{LVA}		1.02	1.07	1.13	V
Regulated output voltage	V_{REG}		1.00	1.05	1.10	V
Demodulation output voltage	Vo		-26	-22	-18	dBs
Limiting sensitivity	V_L	$V_0 = -3dB$ (input)		-	-72	dBm
Demodulation output noise voltage	V _{NO}	Not modulated			-60	dBs
Waveform shaping duty (1)	DR1	$\Delta T = \pm 2.0 \text{kHz}$	40	50	60	%
Waveform shaping duty (2)	DR2	$\Delta T = \pm 4.0 \text{kHz}, \text{Vin} = -25 \text{dBm}$	40	50	60	%
Total harmonic distortion	THD		_		-22	dB
Waveform shaping output voltage (L)	V_{nL}	$V_1 = 0.6V, V_2 = 0V$			0.2	V
Waveform shaping output voltage (H)	V _{nH}	V1=1.05V, V2=0V	2.8			V
Quick-charge/discharge current	I_{QH}	V1=1.1V, V2=3V	35		_	μΑ
Quick-charge/discharge current	I_{QL}	V1=0.3V, V2=3V			-35	μ A

Note) Input signal f_o =455kHz, Δf = ± 7.0 kHz, f_{mod} =400Hz, V_{in} =-45dBm

■ Application Circuit



Mobile Communication

■ Pin Descriptions

Pin No.	Symbol	Description	Equivalent circuit
1	QCC	Quick-charge/discharge control Quick-charge ON when high, and OFF when low.	①————————————————————————————————————
2	IF amp. output	IF amplifier output	$\begin{array}{c c} & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ \end{array}$
3	DET	To be connected to a detector coil.	
4	LVA	Low voltage alarm output	100Ω
5	BSV	Battery saving control	⑤————————————————————————————————————
6	V _{cc}	Supply voltage	
7	REG control	Regulator control	28kΩ
8	REG output	Regulator output	$\begin{array}{cccccccccccccccccccccccccccccccccccc$
9	AF output	Detector output	55kΩ 100kΩ
10	LP output	Filter buffer output	Φ 300%Ω
11	LP input	Filter buffer input	300kΩ
12	GND2	Ground	

■ Pin Descriptions (cont.)

Pin No.	Symbol	Description	Equivalent circuit
13	REF	Comparator reference	300kΩ 300kΩ 9
14	IF input	IF amplifier input	2κΩ × 1 × 1 × 1 × 1 × 1 × 1 × 1 × 1 × 1 ×
15	GND1	Ground	
16	NRZ output	NRZ output	®—————————————————————————————————————



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